

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT2757528

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>YASUO OMORI</td> <td>01/20/2014</td> </tr> <tr> <td>HIROKI HIRAI</td> <td>01/20/2014</td> </tr> <tr> <td>MASAAKI TABATA</td> <td>01/20/2014</td> </tr> </tbody> </table>		Name	Execution Date	YASUO OMORI	01/20/2014	HIROKI HIRAI	01/20/2014	MASAAKI TABATA	01/20/2014		
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CORRESPONDENCE DATA											

Fax Number: (212)725-2452  
Phone: 2127252450  
Email: email@hpiplaw.com  
*Correspondence will be sent via US Mail when the email attempt is unsuccessful.*  
Correspondent Name: HESPOS & PORCO LLP  
Address Line 1: 110 WEST 40TH STREET  
Address Line 2: SUITE 2501  
Address Line 4: NEW YORK, NEW YORK 10018

ATTORNEY DOCKET NUMBER:	FPCT13-292US
NAME OF SUBMITTER:	GERALD E. HESPOS
Signature:	/Gerald E. Hespos/
Date:	03/07/2014

Total Attachments: 1  
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**ASSIGNMENT**

In consideration of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned by the Assignees, 1) AUTONETWORKS TECHNOLOGIES, LTD., a corporation organized under the laws of Japan, located at 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510-8503 Japan, 2) Sumitomo Wiring Systems, Ltd., a corporation organized under the laws of Japan, located at 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510-8503 Japan and 3) SUMITOMO ELECTRIC INDUSTRIES, LTD., a corporation organized under the laws of Japan, located at 5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka, 541-0041 Japan, receipt whereof is hereby acknowledged, the undersigned by these presents hereby sells, assigns, transfers and sets over unto the said assignee the entire right, title and interest in and to the invention or improvement entitled "JOINT CONNECTOR AND ASSEMBLING METHOD THEREOF", said invention being fully described and/or claimed in the application for Letters Patent of the United States of America, executed this date, in and for the United States and all foreign countries, the same to be held and enjoyed by said assignee, its successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patent therefor may be granted, as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

**And Said Assignee Is Hereby Authorized** to make application for and to receive Letters Patent for said invention in any of said countries at its election.

**And By This Covenant The Undersigned** will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patent which may be granted therefor to said Assignee, its successors, assigns or other legal representatives, and, upon the request and at the expense of said assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of any Letters Patent to be granted therefor, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein, without further compensation, but at the expense of said assignee, its successors, assigns or other legal representatives.

**And The Commissioner Of Patents Is Hereby Authorized And Requested** to issue any and all Letters Patent of the United States for said invention, to said assignee.

January 20, 2014  
Date

14 January 20, 2014  
Date

January 20, 2014  
Date

Yasuo Omori  
Yasuo Omori

Hiroki Hirai  
Hiroki Hirai

Masaaki Tabata  
Masaaki Tabata